3-60753-2 ACTIVE

AMP-IN

TE Internal #: 3-60753-2

PCB Terminals, Receptacle, PCB Hole Diameter 1.5 – 1.57 mm [.059

– .062 in], Through Hole - Solder, Post-Tin Plating, Brass, Bag

View on TE.com >



Terminals & Splices > PCB Terminals











PCB Terminal Type: Receptacle

PCB Thickness (Recommended): 3.18 mm [.125 in]
PCB Hole Diameter: 1.5 – 1.57 mm [.059 – .062 in]

Mating Pin Diameter: 1.47 mm [.058 in]

Profile Height from PCB: 5.84 mm [.233 in]

Features

Product Type Features

Troduct Type realures	
PCB Terminal Mounting Style	Stud Mount
Configuration Features	
Stud Hole	No
Terminal Angle	180 °
Body Features	
Finish	Bright
	150 µin
Contact Features	
Contact Plating Material	Tin
PCB Terminal Type	Receptacle
Mating Pin Diameter	1.47 mm[.058 in]
Terminal Plating Material	Post-Tin
Contact Underplating Material	Brass
Terminal Size	Miniature



Terminal Orientation	Straight
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Solder
Product Terminates To	Printed Circuit Board
Mechanical Attachment	
Wire Insulation Support	Without
Dimensions	
Extension Below Board	.76 mm[.029 in]
Receptacle Terminal Stock Thickness	.25 mm[.01 in]
PCB Thickness (Recommended)	3.18 mm[.125 in]
PCB Hole Diameter	1.5 – 1.57 mm[.059 – .062 in]
Profile Height from PCB	5.84 mm[.233 in]
Usage Conditions	
Insulation Option	Uninsulated
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Packaging Features	
Packaging Quantity	1000
Packaging Method	Bag

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant with Exemptions
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) SVHC > Threshold: Pb (3.7% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free



Solder Process Capability

Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

















Documents

Product Drawings
.058 DIA PIN TPBR

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_3-60753-2_U3.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_3-60753-2_U3.3d_igs.zip



English

Customer View Model

ENG_CVM_CVM_3-60753-2_U3.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

PRINTED CIRCUIT BOARD TERMINALS AND DISCONNECTS

English

Product Specifications

Application Specification

English